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STATEMENT UNDER 37 CFR 3.73(b)

26FT-003

Applicant/Patent Owner: **TOYODA GOSEI CO., LTD.**Application No./Patent No. **09/963,801** Filed/Issue Date: **9/27/2001**Entitled: **MOUNTING STRUCTURE OF CLIP TO RESIN MOLDED ARTICLE AND MOUNTING STRUCTURE AND MANUFACTURING METHOD OF RESIN MOLDED ARTICLE**

TOYODA GOSEI CO., LTD., a **Corporation**
 (Name of Assignee) (Type of Assignee, e.g., corporation, partnership, university, government agency, etc.)

states that it is:

1. the assignee of the entire right, title, and interest; or
2. an assignee of less than the entire right, title and interest.

The extent (by, percentage) of its ownership interest is _____ %

in the patent application/patent identified above by virtue of either:

A. An assignment from the inventor(s) of the patent application/patent identified above. The assignment was recorded in the United States Patent and Trademark Office at Reel **012331**, frame **0502**, or for which a copy thereof is attached.

OR

B. A chain of title from the inventor(s), of the patent application/patent identified above, to the current assignee as shown below:

1. From: _____ To: _____
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Additional documents in the chain of title are listed on a supplemental sheet.

Copies of assignments or other documents in the chain of title are attached.

[NOTE: A separate copy (i.e., the original assignment document or a true copy of the original document) must be submitted to Assignment Division in accordance with 37 CFR Part 3, if the assignment is to be recorded in the records of the USPTO. See MPEP 302.08]

The undersigned (whose title is supplied below) is authorized to act on behalf of the assignee.

Nov. 19, 2002
 Date

Katsuhiko Nakayama

Typed or printed name

Katsuhiko Nakayama
 Signature

General Manager, Intellectual Property Division

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POWER OF ATTORNEY OR
AUTHORIZATION OF AGENT

Application Number	09/963,801
Filing Date	9/27/2001
First Name Inventor	Tetsuya MIYANO
Title	MOUNTING STRUCTURE OF CLIP TO RESIN MOLDED ARTICLE
Group Art Unit	3677
Examiner Name	MELWANI, DINESH
Attorney Docket No.	26FT-003

I hereby appoint:

 Practitioners at Customer Number

23400



OR

 Practitioner(s) named below:

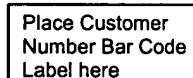
Name	Registration Number

as my/our attorney(s) or agent(s) to prosecute the application identified above, and to transact all business in the United States Patent and Trademark Office connected therewith.

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Country

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I am the:

 Applicant/Inventor Assignee of record of the entire interest. See 37 CFR 3.71.

Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96).

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SIGNATURE of Applicant or Assignee of Record

Name	Katsuhiko Nakayama General Manager, Intellectual Property Division, TOYODA GOSEI CO., LTD.
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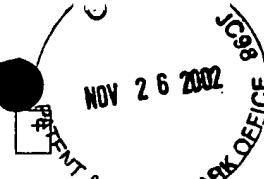
Signature	
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Date	Nov. 19, 2002
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NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below*.

*Total of _____ forms are submitted.

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FG-172U/00P00044US0
PTO/SB/82 (10-00)

Approved for use through 10/31/2002. OMB 0651-0035
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REVOCATION OF POWER OF ATTORNEY OR AUTHORIZATION OF AGENT

Application Number	09/963,801
Filing Date	9/27/2001
First Named Inventor	Tetsuya MIYANO
Title	MOUNTING STRUCTURE OF CLIP TO RESIN MOLDED ARTICLE
Group Art Unit	3677
Examiner Name	MELWANI, DINESH
Attorney Docket No.	26FT-003

I hereby revoke all previous powers of attorney or authorizations of agent given in the above-identified application:

A Power of Attorney or Authorization of Agent is submitted herewith

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Applicant/Inventor

Assignee of record of the entire interest. See 37 CFR 3.71.

Statement under 37 CFR 3.73(b) is enclosed. (Form PTO/SB/96).

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SIGNATURE of Applicant or Assignee of Record

Name Katsuhiko Nakayama
General Manager, Intellectual Property Division, TOYODA GOSEI CO., LTD.

Signature *Katsuhiko Nakayama*

Date Nov. 19, 2002

NOTE: Signatures of all the inventors or assignees of record of the entire interest or their representative(s) are required. Submit multiple forms if more than one signature is required, see below*.

*Total of _____ forms are submitted.

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